# 74LVC541A

# Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Rev. 4 — 25 November 2011

**Product data sheet** 

### 1. General description

The 74LVC541A is an octal non-inverting buffer/line driver with 5 V tolerant inputs and outputs. The 3-state outputs are controlled by the output enable inputs OE1 and OE2.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Inputs can be driven from either 3.3~V or 5~V devices. When disabled, up to 5.5~V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3~V and 5~V applications.

### 2. Features and benefits

- 5 V tolerant inputs for interlacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ♦ HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115B exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



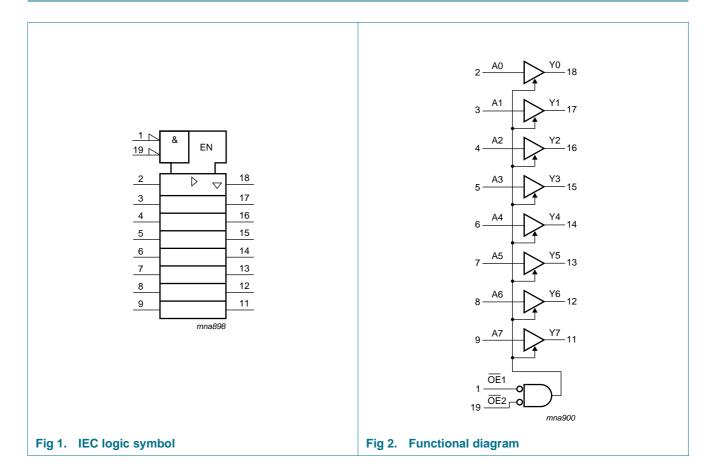
### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

# 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC541AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVC541ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVC541APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVC541ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 $\times$ 4.5 $\times$ 0.85 mm	SOT764-1

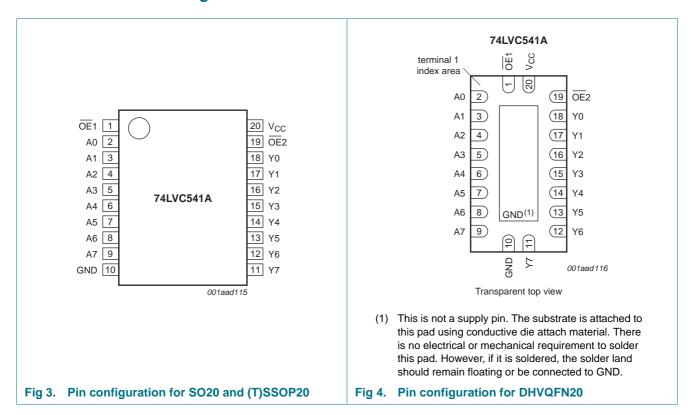
# 4. Functional diagram



#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

# 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2. Pin description

	The second secon	
Symbol	Pin	Description
OE1	1	output enable input (active LOW)
A[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
Y[0:7]	18, 17, 16, 15, 14, 13, 12, 11	bus output
OE <sub>2</sub>	19	output enable input (active LOW)
V <sub>CC</sub>	20	supply voltage

#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

# 6. Functional description

Table 3. Functional table[1]

Input OE1		Output	
OE1	OE2	An	Yn
L	L	L	L
L	L	Н	Н
X	Н	X	Z
Н	X	X	Z

<sup>[1]</sup> H = HIGH voltage level

L = LOW voltage level

### 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
$V_{I}$	input voltage		<u>[1]</u> –0.5	+5.5	V
$I_{OK}$	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
$V_{O}$	output voltage	output HIGH or LOW state	<u>[2]</u> -0.5	$V_{CC} + 0.5$	V
		output 3-state or power-down	<u>[2]</u> -0.5	+6.5	V
I <sub>O</sub>	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-60	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3] _	500	mW

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

X = don't care

Z = high-impedance OFF-state

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SO20 packages: above 70 °C the value of  $P_{tot}$  derates linearly with 8 mW/K. For (T)SSOP20 packages: above 60 °C the value of  $P_{tot}$  derates linearly with 5.5 mW/K. For DHVQFN20 packages: above 60 °C the value of  $P_{tot}$  derates linearly with 4.5 mW/K.

#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	$V_{CC}$	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall	V <sub>CC</sub> = 2.3 V to 2.7 V	0	-	20	ns/V
	rate	V <sub>CC</sub> = 2.7 V to 3.6 V	0	-	10	ns/V

#### 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V <sub>IL</sub> LOW-level		V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>OH</sub> HIGH-level		$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V <sub>CC</sub> - 0.2	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
$V_{OL}$	LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	8.0	V

#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

**Table 6.** Static characteristics ...continued
At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-4	0 °C to +85	5 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
lı	input leakage current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 3.6 \text{ V}$	-	±0.1	±5	-	±20	μА
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = 5.5$ V or GND; $V_{CC} = 3.6$ V	-	±0.1	±5	-	±20	μА
l <sub>OFF</sub>	power-off leakage current	$V_I$ or $V_O = 5.5$ V; $V_{CC} = 0.0$ V	-	±0.1	±10	-	±20	μА
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6 \text{ V}$	-	0.1	10	-	40	μΑ
$\Delta I_{CC}$	additional supply current	per input pin; $V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	5	500	-	5000	μА
C <sub>I</sub>	input capacitance		-	5.0	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		<b>-40</b> '	°C to +8	5 °C	–40 °C to	Unit	
			ı	Min	Typ[1]	Max	Min	Max	
$t_{pd}$	propagation	An to Yn; see Figure 5	1						
	delay	V <sub>CC</sub> = 1.2 V		-	14.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.5	13.8	1.5	16.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $V_{CC} = 2.7 \text{ V}$ $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.5	6.8	1.0	7.9	ns
				1.5	3.5	5.6	1.5	7.0	ns
				1.0	2.9	5.1	1.0	6.5	ns
t <sub>en</sub>	enable time	OEn to Yn; see Figure 6	]						
		V <sub>CC</sub> = 1.2 V		-	20.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		1.8	7.7	16.0	1.8	18.5	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.5	4.3	8.8	1.5	10.2	ns
		V <sub>CC</sub> = 2.7 V		1.5	4.4	7.5	1.5	9.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	3.5	7.0	1.0	9.0	ns
$t_{dis}$	disable time	OEn to Yn; see Figure 6	]						
		V <sub>CC</sub> = 1.2 V		-	11.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	;	3.0	4.9	10.3	3.0	11.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.7	5.9	1.0	6.8	ns
		V <sub>CC</sub> = 2.7 V		1.5	3.7	7.0	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.3	6.0	1.0	7.5	ns

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#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		<b>-40</b>	°C to +8	5 °C	-40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
$C_{PD}$	power	per input; $V_I = GND$ to $V_{CC}$	4]						
dissipation capacitance	V <sub>CC</sub> = 1.65 V to 1.95 V		-	7.7	-	-	-	pF	
	сараспапсе	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	11.3	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		14.4	-	-	-	pF

- [1] Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.2$  V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \text{ where:}$ 

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

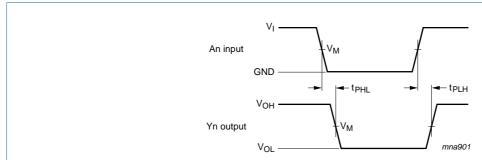
C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs.

#### 11. AC waveforms



 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V}.$ 

 $V_{M}$  = 0.5  $\times$   $V_{CC}$  at  $V_{CC}$  < 2.7 V.

 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 5. Input (An) to output (Yn) propagation delays

#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

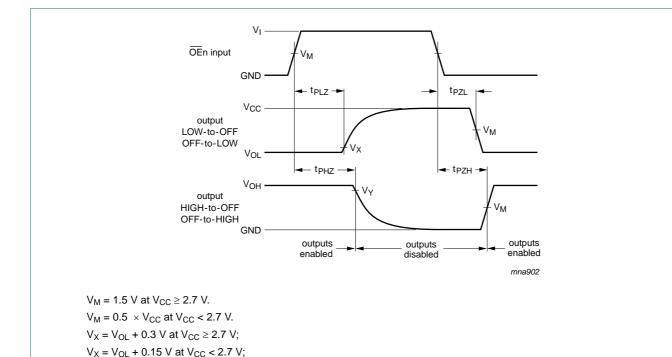
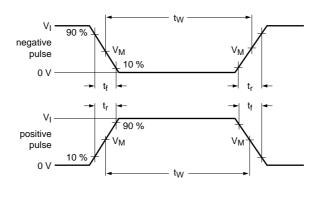


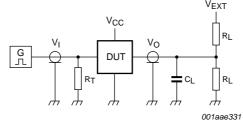
Fig 6. 3-state enable and disable times

 $V_Y = V_{OH} - 0.3 \text{ V at } V_{CC} \geq 2.7 \text{ V};$   $V_Y = V_{OH} - 0.15 \text{ V at } V_{CC} < 2.7 \text{ V}.$ 

 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state





Test data is given in Table 8.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

Table 8. Test data

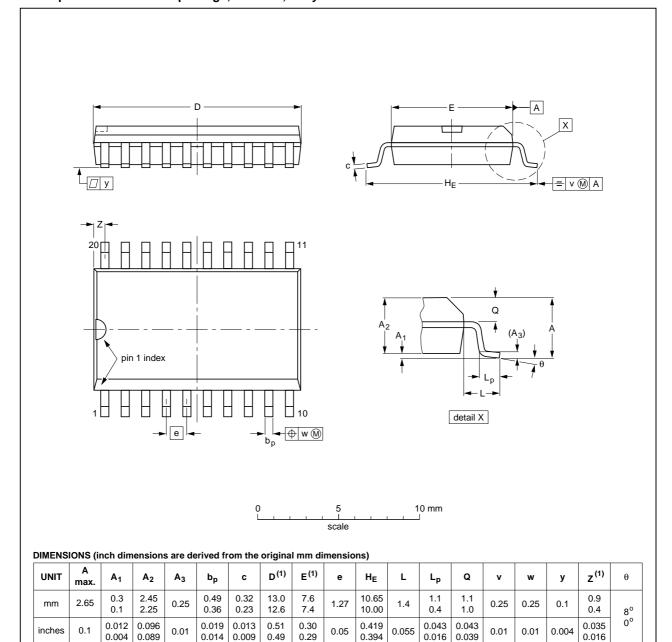
Supply voltage	Input		Load		V <sub>EXT</sub>	V <sub>EXT</sub>				
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	$t_{PLZ}, t_{PZL}$	t <sub>PHZ</sub> , t <sub>PZH</sub>			
1.2 V	$V_{CC}$	≤ 2 ns	30 pF	1 k $\Omega$	open	$2\times V_{CC}$	GND			
1.65 V to 1.95 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
2.3 V to 2.7 V	$V_{CC}$	≤ 2 ns	30 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND			

#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

# 12. Package outline

#### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	VERSION IEC JEDEC JEITA			PROJECTION	ISSUE DATE	
SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19

Fig 8. Package outline SOT163-1 (SO20)

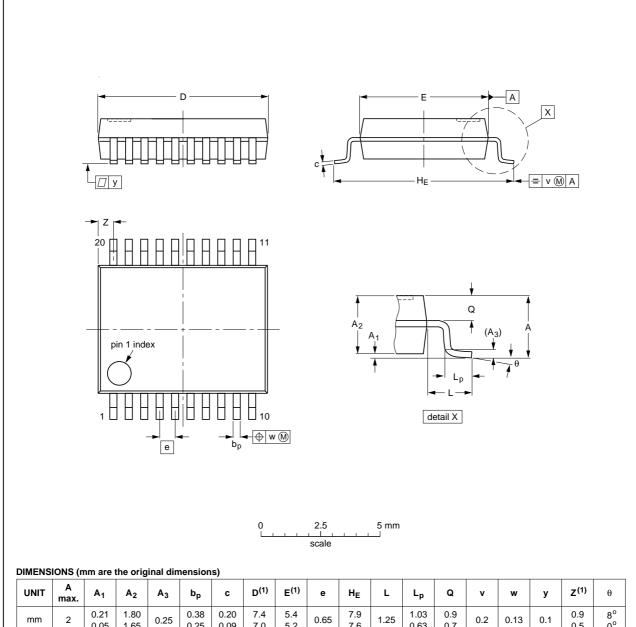
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#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

#### SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

#### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT339-1		MO-150				<del>99-12-27</del> 03-02-19

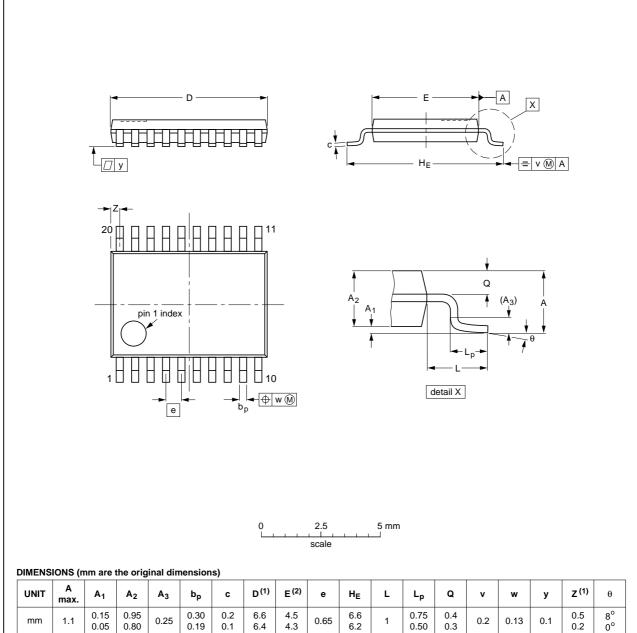
Fig 9. Package outline SOT339-1 (SSOP20)

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#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

#### TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



#### NI - 4 - -

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT360-1		MO-153				<del>99-12-27</del> 03-02-19

Fig 10. Package outline SOT360-1 (TSSOP20)

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Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

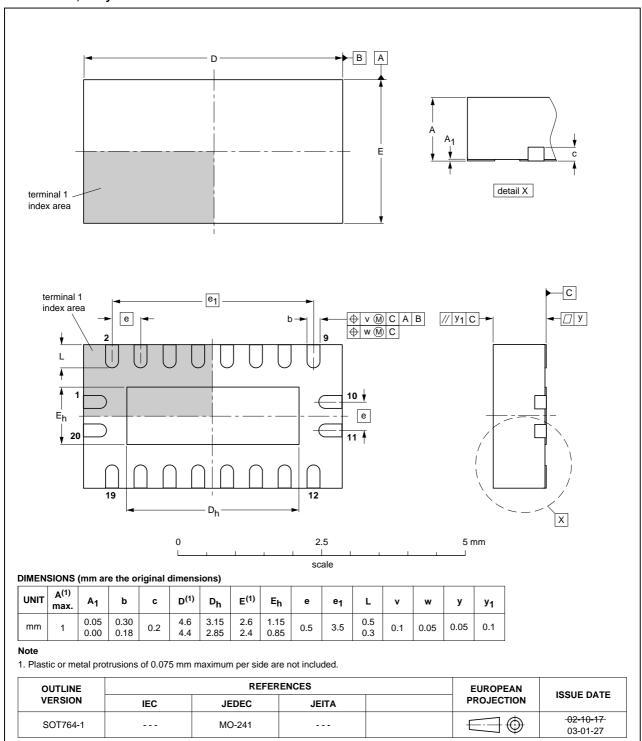


Fig 11. Package outline SOT764-1 (DHVQFN20)

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#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

# 13. Abbreviations

#### Table 9. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
MM	Machine Model
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

# 14. Revision history

#### Table 10. Revision history

	•					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC541A v.4	20111125	Product data sheet	-	74LVC541A v.3		
Modifications:	<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>					
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
	• Table 4, Table 5, Table 6, Table 7 and Table 8: values added for lower voltage ranges.					
74LVC541A v.3	20031112	Product specification	-	74LVC541A v.2		
74LVC541A v.2	20030514	Product specification	-	74LVC541A v.1		
74LVC541A v.1	19980729	Product specification	-	-		

#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

### 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

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#### Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

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